



Minutes of Meeting

Herschel

Date:	21/03/03	Chairman:	Armin Hauser
Doc.-No.:	HP-2-ASED-MN-0330	Secretary:	Horst Faas
Meeting place:	ASED, Friedrichshafen	Close of Meeting:	Close of Meeting
Date/Time:	21/03/03, 09h00		
Agenda dated:	See attached		

Subject: SPIRE Thermal Model Meeting

Participants:	RAL/MSSL: S. Hayes, AS Goizel ASED: H. Faas, K. Wagner, A. Hauser <i>M. Langfermann (p/t)</i> <i>S. Pastorello (p/t)</i>	Additional Distribution:	Dr. Moritz, W. Ruhe, E. Holzle, J. Kroeker, M. Langfermann, R. Hohn
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Page: 1 of 7 Page(s) plus Annex 1, 2 and 3

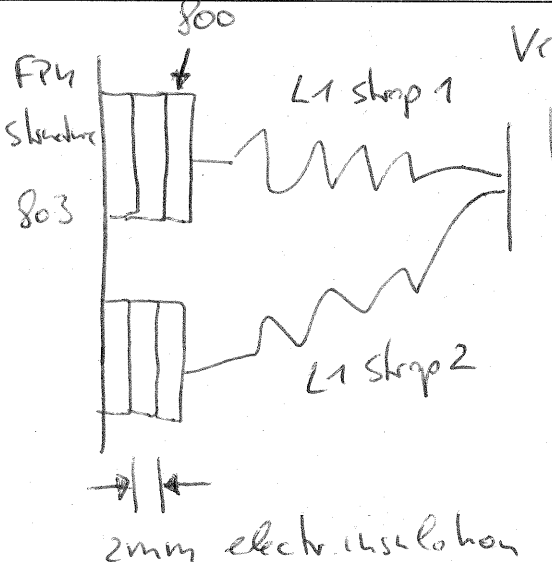
Brief-Minutes (except following sheets)

Summary of Results of Sheets 2 till

Reference	Results	Remarks
	<p><u>Agenda</u> :</p> <ol style="list-style-type: none"> 1. Discussion of new Astrium results 2. Further simplification of SPIRE absorption cooler modelling 3. Identification of evolution of HEPLH Detailed TMM compared to HEPLH Reduced Model (available at RAL) 4. AOB <p><u>Iter 1</u> :</p> <p>The detailed profiles during the recycling period have been discussed.</p> <p>RAL / ASGonzel will provide an updated table / description how the neutral dissipation profiles assumed in the Spire TMM are derived.</p>	

Reference	Results	Remarks
	<p>RAL/AS Coritel will update the SPIRE Reduced ITHM to change the test scratch duration (to 30 sec)</p> <p>The hinsteps during the recycling period in the ITHM was discussed.</p> <p>It was agreed that the setting of the thermal links to zero-heat capacity is a correct representation for the model run.</p> <p>RAL/AS Coritel should ^{check} the sensitivity of the timesteps used. The minimum timestep used in the detailed ITHM is 0.01 sec. Astrium allows 0.001 sec.</p>	

Reference	Results	Remarks
	<p><u>Local - 1 Thermal I/F:</u></p> <p>RAL will double the I/F conductance in the Reduced ITHM.</p> <p>Currently ASED assumes that the I/F mode (800) is at the Instrument side. But Astrium assumes that it is defines the torque (2.7 Nm). If this has to be changed (due to the electrical insulation) the node position is may be moved to the ASED strap side.</p> <p>Action RAL and Astrium to add a joint on each side of Node 800 to account for the electrical insulation conductance.</p>	

Reference	Results	Remarks
	 <p>800</p> <p>FP4 Structure</p> <p>803</p> <p>L1 strip 1</p> <p>Ventline</p> <p>L1 strip 2</p> <p>2mm elect. insulation</p> <p>STYCAST 1266</p> <p>18 cm² contact area</p>	<p>Conductance Assumption of sandwich:</p> $0.12 \frac{W}{K} \text{ (at 4K)}$ <p><u>Level-1 with electrical insulation.</u></p> <p>For the <u>Level-0</u> thermal strip the responsibility of Astrium is includes the contact conductance to the SPIRE Thermal strip (node 815, 815 and 816). See Annex 1.</p> <p><u>Level-3 strip</u></p> <p>RAL to add thermal resistance of electrical insulation required, in the reduced ITRM.</p>

Reference	Results		Remarks
23	<p>I/F nodes are not just have to be introduced introduced to cater for the electrical insulation.</p>		
		Structure	I/F node
	Proto. JFET	801	831
Specr. JFET	802	832	
<p>RAL and ASED agreed to use the following figures for L3 I/F. The values need to be confirmed for the Thermal I/F Mtg. on 3 April 2003.</p>			
	Specr. JFET	Proto JFET	
P	$\leq 15 \text{ mW}$	$\leq 42 \text{ mW}$	
T_{L3}	$\leq 12 \text{ K}$	$\leq 14 \text{ K}$	
C	$\leq 0.002 \frac{\text{W}}{\text{K}}$	$\leq 0.002 \frac{\text{W}}{\text{K}}$	

(8-12k;
 valid temp.
 range)

(8-14k;
 valid temp. range)

Reference	Results	Remarks
	<p><u>Item 3: Evolution of HEPLO Detailed Model</u></p> <ul style="list-style-type: none"> - L-3 I/F introduction (0.4K) - decoupling of harness (0.3K) - HIFI coax harness modification - beam entrance baffles and telescope refinement <p>RAL / AS Coital should perform an average load model run and check the HOB plate temperature.</p> <p>The absorption costs <u>Absorption Costs</u></p> <p>To guarantee $\leq 3K$ through-out and $\leq 2K$ at the end of recycling requires an accurate load profile on the evaporator step.</p>	

Reference	Results	Remarks
	<p><u>Ophos</u></p> <p>1. Accurate thermo-dynamic model of the coils</p> <p>2. Test the sensitivity to temperature with the 6 litre cooler and variable impedance of the L-O evaporator shap</p> <p>Astrum stated that the current analysis^{shunt} reveals a conductance of $80 \frac{\text{mW}}{\text{K}}$ (to HeII) on the ASED part of the evaporator shap. This figure can be achieved without opening the HeII tank.</p>	

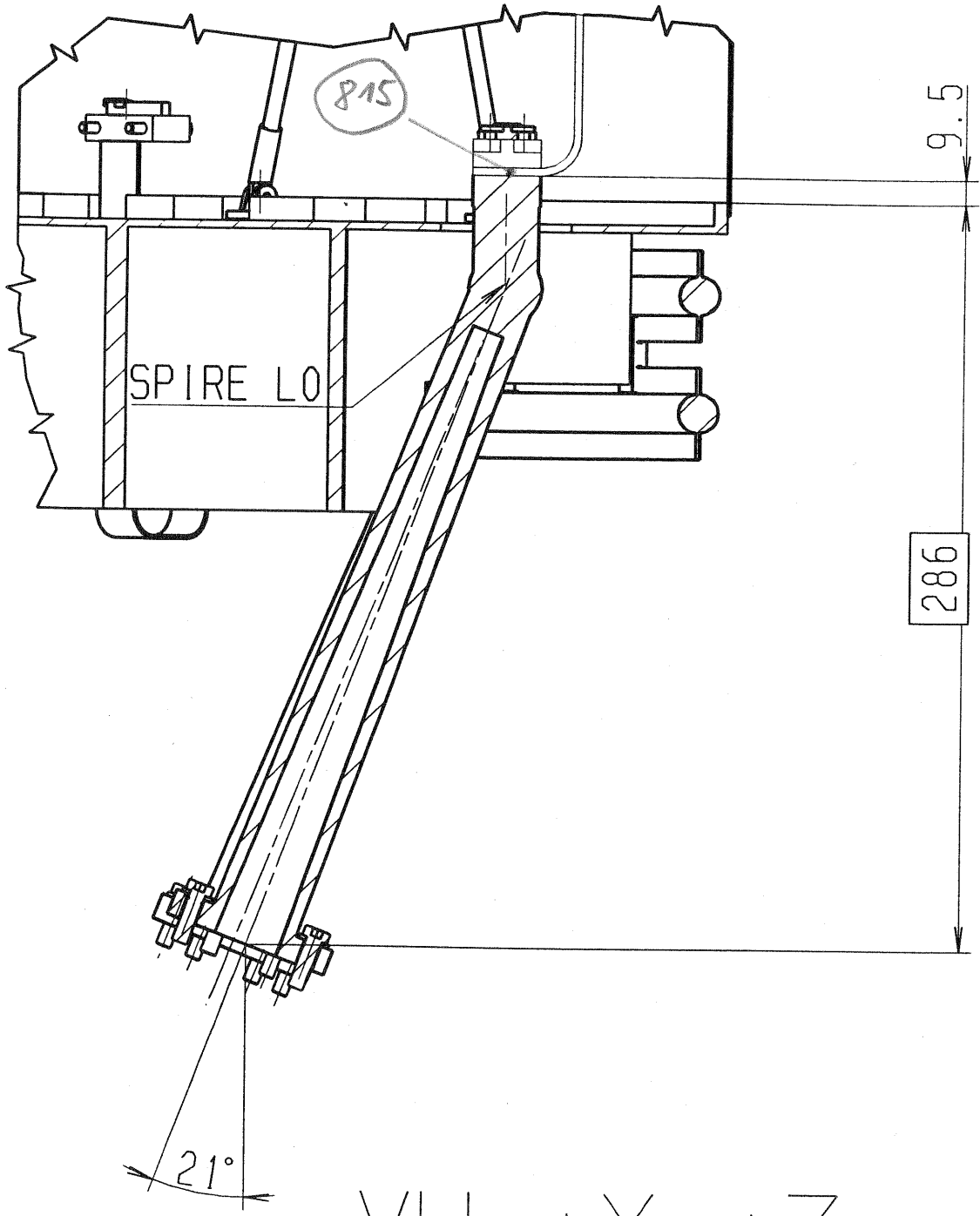
Reference	Results	Remarks
	<p><u>He II loss</u></p> <p>The He II tank has been increased. The end-of-life time He II is currently only 5kg. This is not realistic, a better more realistic value is 35kg. (constant name: HE in HE 11)</p>	

6-7

SCALE 1:2.5

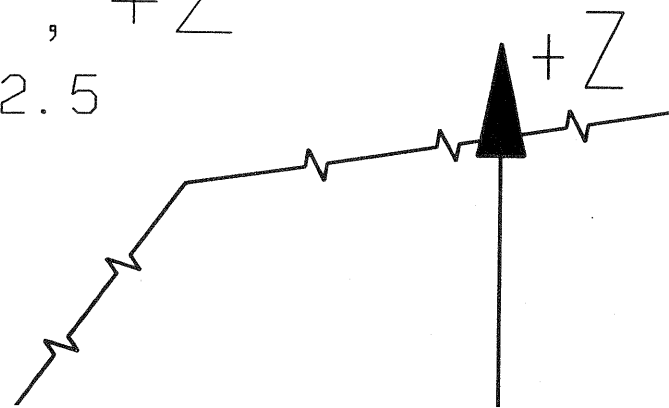
PUMP I/F

on strap side



VU + Y, + Z

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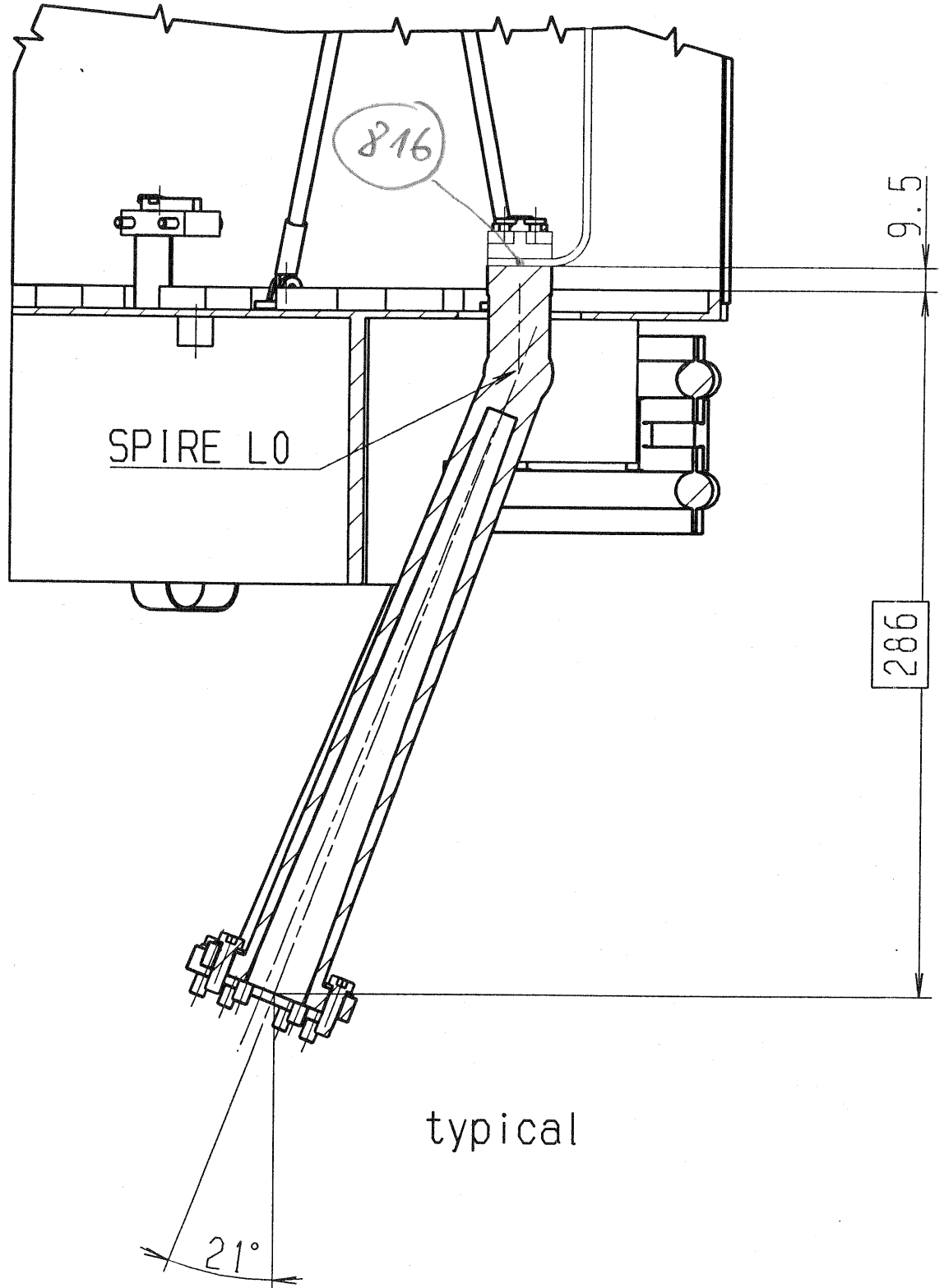
P-P

Evaporator

6-7

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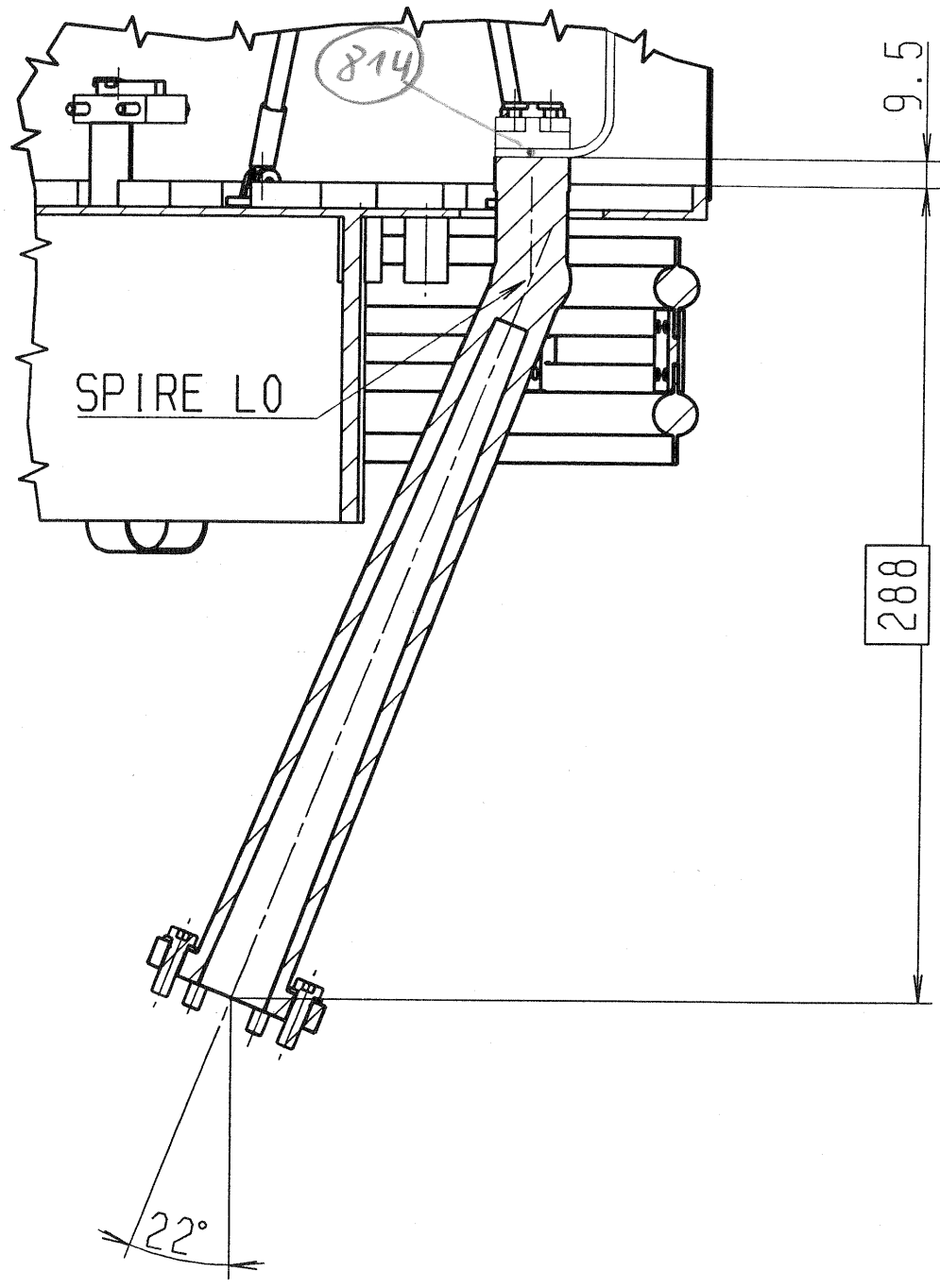
on strap side



R-R
6-7
SCALE 1:2.5

Detector
Enclosure

on strap side



M
L
K
J
I

Name	Dep./Comp.		Name	Dep./Comp.
Alberti von Mathias Dr.	SM 34		Schäffler Johannes	OTN/EN 64
Alo Hakan	OTN/IP 35	X	Schink Dietmar	ED 422
Barlage Bernhard	ED 11		Schlosser Christian	OTN/EN 64
Bayer Thomas	ED 541		Schweickert Gunn	SM 34
X Faas Horst	EA 65		Stauss Oliver	SM 33
Fehringer Alexander	SM 33		Steininger Eric	ED 422
Frey Albrecht	ED 422		Stritter Rene	ED 11
Gerner Willi	ED 11		Suttner Klaus	SM 32
Grasl Andreas	OTN/EN 64		Tenhaeff Dieter	SM 34
Grasshoff Brigitte	ED 521		Thörmer Klaus-Horst Dr.	OTN/ED 65
Hartmann Hans Dr.	ED 422		Wagner Adalbert	OTN/IP 35
X Hauser Armin	SM 31	X	Wagner Klaus	SM 31
Hinger Jürgen	SM 31	X	Wietbrock, Walter	ED 521
X Hohn Rüdiger	ED 541		Wöhler Hans	SM 34
X Hölzle Edgar	ED 421		Zipf Ludwig	ACE 32
Huber Johann	ED 543			
Hund Walter	SE 76			
Idler Siegmund	ED 432	X	Alcatel	ASP
Ivány von András	ACE 32	X	ESA/ESTEC	ESA
Jahn Gerd Dr.	SM 31		Instruments:	
Kalde Clemens	ED 532		MPE (PACS)	MPE
Kameter Rudolf	OTN/EN 64	X	RAL (SPIRE)	RAL
Kersting Stefan	OTN/EN 63		SRON (HIFI)	SRON
Kettner Bernhard	SM 34		Subcontractors:	
Knoblauch August	ED 531		Air Liquide, Space Department	AIR
Koelle Markus	ED 533		Air Liquide, Orbital System	AIRT
X Kroeker Jürgen	ED 542		Alcatel Bell Space	ABSP
Kunz Oliver	SM 31		Astrium Sub-Subsyst. & Equipment	ASSE
Lamprecht Ernst	OTN/SM 222		Austrian Aerospace	AAE
Lang Jürgen	SE 76		APCO Technologies S. A.	APCO
X Langfermann Michael	ED 541		Astrium GmbH Space Infrastr.	ASIP
Mack Paul	OTN/EN 64		Bieri Engineering B. V.	BIER
X Moritz Konrad Dr.	ED 65		BOC Edwards	BOCE
Müller Lutz	OTN/EN 64		Dutch Space Solar Arrays	DSSA
Muhl Eckhard	OTN/EN 64		EADS CASA Espacio	CASA
X Pastorino Michel	ASPI Resid.		EADS CASA Espacio	ECAS
Peitzker Helmut	ED 65		Eurocopter	ECDE
Peltz Heinz-Willi	SM 33		HTS AG Zürich	HTSZ
Peters, Gerhard	ED 531		Linde	LIND
Pietroboni Karin	ED 65		Patria New Technologies Oy	PANT
Puttlitz Joachim	OTN/EN 64		Phoenix, Volkmarsen	PHOE
Rebholz Reinhold	ED 541		Prototech AS	PROT
Reuß Friedhelm	ED 62		Rembe, Brilon	REMB
X Rühle Wolfgang	ED 6		SENER Ingenieria SA	SEN
Runge Axel	OTN/EN 64		Stöhr, Königsbrunn	STOE
Sachsse Bernt	ED 21		RYMSA, Radiación y Microondas S.A.	RYM